

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lay bed ON Semiconductor and its officers, employees, ween if such claim alleges that ON Semiconductor was negligent regarding the d



FDD8444

N-Channel PowerTrench[®] MOSFET

40V, 50A, 5.2m Ω

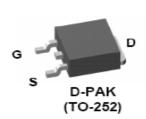
Features

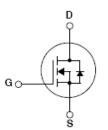
- Typ $r_{DS(on)}$ = 4m Ω at V_{GS} = 10V, I_D = 50A
- Typ Q_{g(10)} = 89nC at V_{GS} = 10V
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse/ Repetitive Pulse)
- Qualified to AEC Q101
- RoHS Compliant



Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Transmission
- Distributed Power Architecture and VRMs
- Primary Switch for 12V Systems





1

FDD8444 N-Channel PowerTrench[®] MOSFET

March 2015

Т
ŏ
D ⁸
4
4
4
7
<u> </u>
Ô
÷
ā
nn
Φ
Τ
Q
OWe
Õ
.
Ţ
6
Ť
ō
5
2
2
ð
Ο
S
Т
Ш
-
-

MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain to Source Voltage	40	V
V _{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (V _{GS} = 10V) (Not	e 1) 145	
I _D	Continuous (V _{GS} = 10V, with $R_{\theta JA}$ = 52°C/W)	20	A
	Pulsed	Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Not	e 2) 535	mJ
D	Power Dissipation	153	W
PD	Derate above 25°C	1.02	W/ºC
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case	0.98	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient TO-252, 1in ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8444	FDD8444	TO-252AA	13"	16mm	2500 units

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units

Off Characteristics

B_{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} =	= 0V	40	-	-	V
1	Zero Gate Voltage Drain Current	V _{DS} = 32V		-	-	1	uА
DSS		$V_{GS} = 0V$	T _J = 150 ^o C	-	-	250	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

On Characteristics

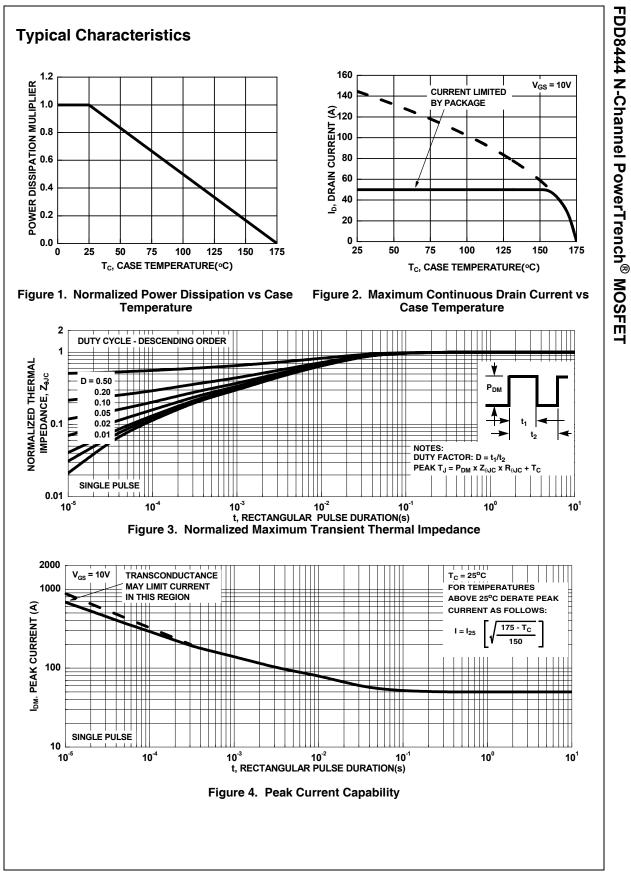
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2	2.5	4	V
		I _D = 50A, V _{GS} = 10V	-	4	5.2	
r _{DS(on)}	Drain to Source On Resistance	I _D = 50A, V _{GS} = 10V, T _J = 175 ^o C	-	7.2	9.4	mΩ

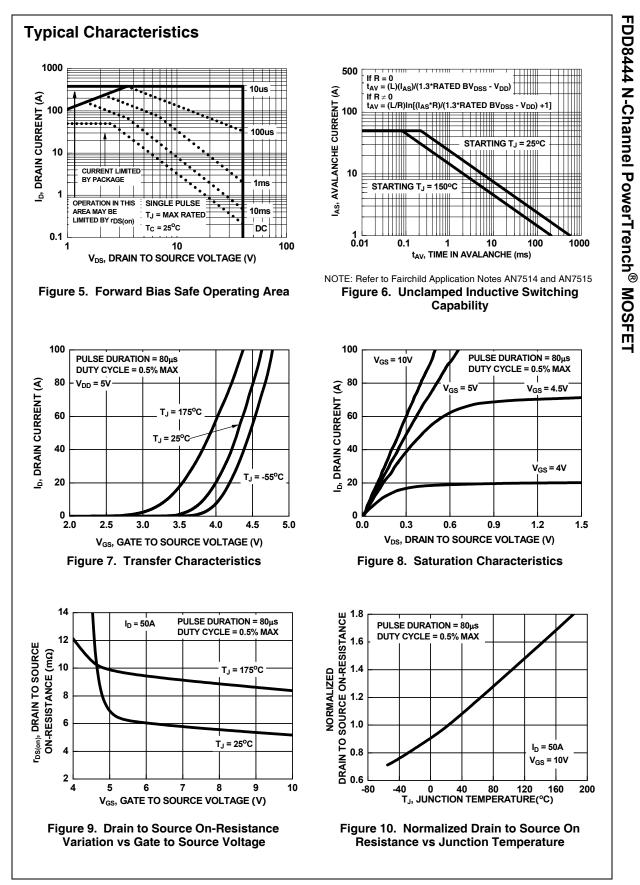
Dynamic Characteristics

C _{iss}	Input Capacitance		0) (-	6195	-	pF
C _{oss}	Output Capacitance	−V _{DS} = 25V, V _{GS} = (−f = 1MHz	UV,	-	585	-	pF
C _{rss}	Reverse Transfer Capacitance			-	332	-	pF
R _G	Gate Resistance	f = 1MHz		-	1.9	-	Ω
Q _{g(TOT)}	Total Gate Charge at 10V	V _{GS} = 0 to 10V		-	89	116	nC
Q _{g(5)}	Total Gate Charge at 5V	V_{GS} = 0 to 5V			43	56	nC
Q _{g(TH)}	Threshold Gate Charge	V_{GS} = 0 to 2V	V _{DD} = 20V I _D = 50A	-	11	14.3	nC
Q _{gs}	Gate to Source Gate Charge		$I_0 = 30A$ $I_0 = 1.0mA$	-	23	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		.y	-	11	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	20	-	nC

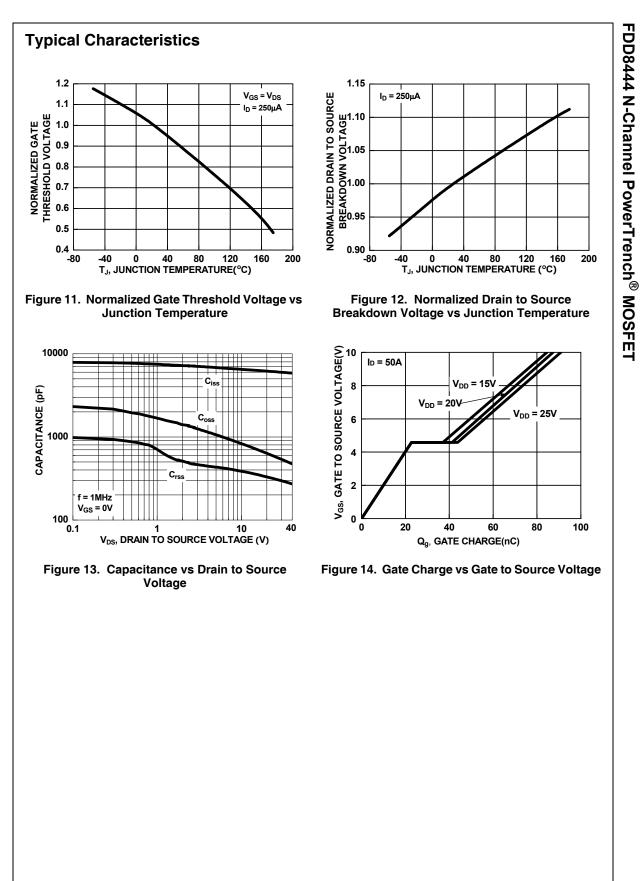
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
witch	ning Characteristics					
on	Turn-On Time		-	-	135	ns
	Turn-On Delay Time		-	12	-	ns
	Turn-On Rise Time $V_{DD} = 20V$, $I_D = 50A$ $V_{CS} = 10V$, $R_{CS} = 2\Omega$	-	78	-	ns	
t_r Turn-On Rise Time $V_{DD} = 20V, I_D = 50A$ - 78	-	ns				
	$\frac{1}{10000000000000000000000000000000000$		-	15	-	ns
off	Turn-Off Time		-	-	95	ns
rain-S	ource Diode Characteristics	i				
SD	Source to Drain Diode Voltage	I _{SD} = 50A	-	0.9	1.25	v
		I _{SD} = 25A	-	0.8	1.0	
r	Reverse Recovery Time	I _F = 50A, dI _F /dt = 100A/μs	-	39	51	ns
rr	Reverse Recovery Charge	F, F (-	45	59	nC
otes: Package o Starting T	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25ºC, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25ºC, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. _J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. J = 25°C, L = 0.67mH, I _{AS} = 40A					
Package of	current limitation is 50A. J = 25°C, L = 0.67mH, I _{AS} = 40A					

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/ All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.





FDD8444 Rev. 1.G





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC